

- Max  $r_{DS(on)}$  = 6.0 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 21 A
- 100% UIL test
- RoHS Compliant

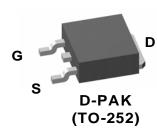


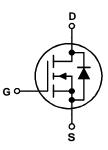
## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$  and fast switching speed.

# Applications

- Vcore DC-DC for Desktop Computers and Servers
- VRM for Intermediate Bus Architecture





## MOSFET Maximum Ratings T<sub>C</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			25	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		50		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		131		
ID	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	27	Α	
	-Pulsed			200		
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 3)		(Note 3)	72	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		65	14/	
	Power Dissipation $T_A = 25 \text{ °C}$ (Note 1a)		(Note 1a)	3.7	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +175	°C	

## **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/VV

## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6760A	FDD6760A	D-PAK (TO-252)	13 "	16 mm	2500 units

March 2015

Max	Units
	V
	mV/°C
1	μΑ
±100	nA
3.0	V
	mV/°C
3.2	
6.0	mΩ
4.9	
	S
3170	pF
700	pF

pF

Ω

ns

ns

ns

ns

nC

nC

nC

nC

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$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		16		m
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	
On Char	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	1.0	1.6	3.0	1
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-7	-	m
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 27 A		2.3	3.2	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 21 A		4.4	6.0	,
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 27 A, T <sub>J</sub> = 150 °C		3.5	4.9	1
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 27 A		186		
Dynamie	c Characteristics					
C <sub>iss</sub>	Input Capacitance			2380	3170	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V, f = 1MHz		525	700	
C <sub>rss</sub>	Reverse Transfer Capacitance			470	710	
Rg	Gate Resistance	f = 1MHz		1.3		
Switchir	ng Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			10	20	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 13 V, I <sub>D</sub> = 27 A,		9	18	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		28		
t <sub>f</sub>	Fall Time			6		
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		44	62	
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V} \text{ V}_{DD} = 13 \text{ V},$		25	35	
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 17 A		6		

**Test Conditions** 

 $I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ 

Min

25

Тур

## **Drain-Source Diode Characteristics**

Gate to Drain "Miller" Charge

Ven Source to Drain Diode Forward Voltade	Source to Drain Diode, Ferward Voltage	$V_{GS} = 0 V, I_S = 3.1 A$ (N	Note 2)	0.7	1.2	V	
	$V_{GS} = 0 V, I_S = 27 A$ (N	Note 2)	0.8	1.3	v		
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 27A, di/dt = 100 A/μs		21	34	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$F_{\rm F} = 27$ A, $u/ul = 100$ A/µs		8	16	nC	

Notes:

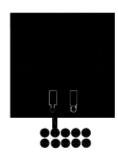
 $Q_{gd}$ 

Symbol

**BV**<sub>DSS</sub>

**Off Characteristics** 

1: R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design while R<sub>0JA</sub> is determined by the user's board design.

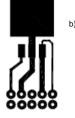


**Electrical Characteristics**  $T_J$  = 25 °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

a) 40 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



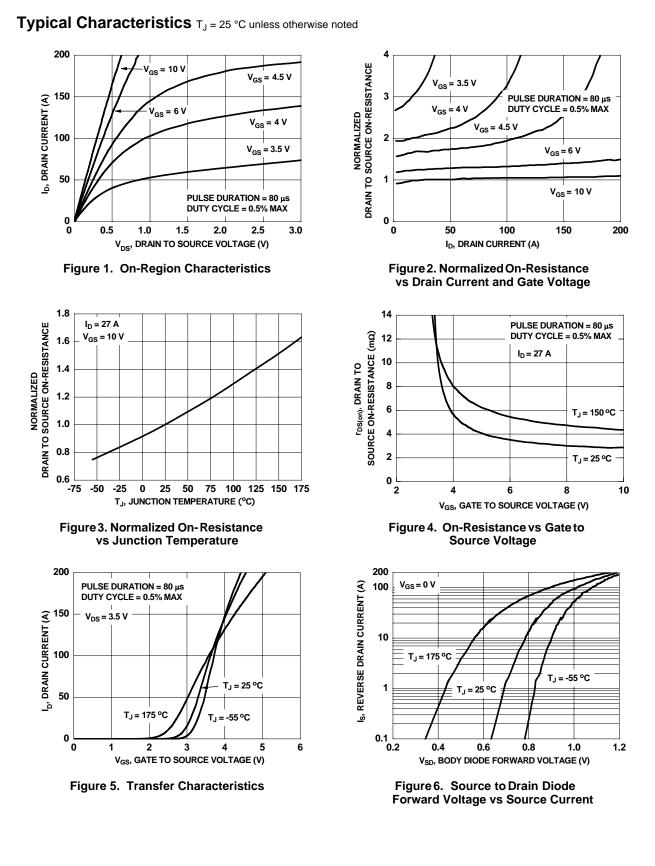
b) 96 °C/W when mounted on a minimum pad.

9.9

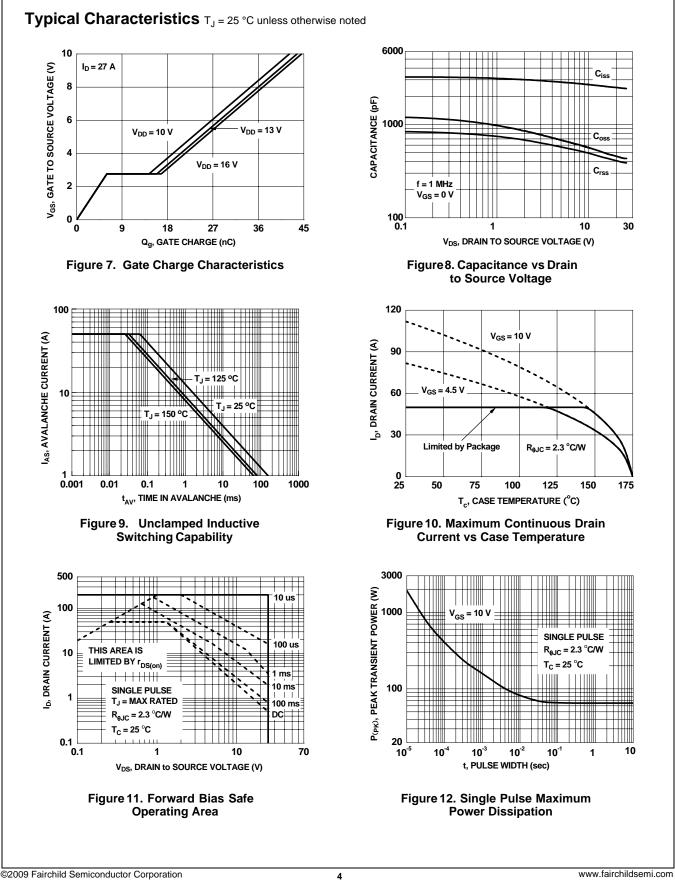
**2:** Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%. **3:** E<sub>AS</sub> of 72 mJ is based on starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 12 A, V<sub>DD</sub> = 23 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 29 A.

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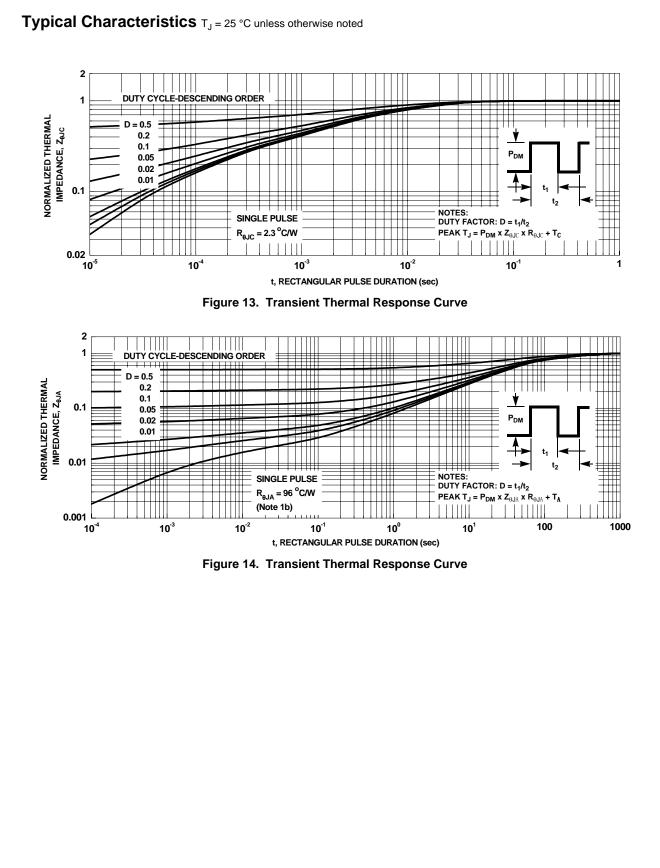


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